

9097250 TOSHIBA (DISCRETE/OPTO)

90D 16022 DT-33-35

# TOSHIBA SEMICONDUCTOR

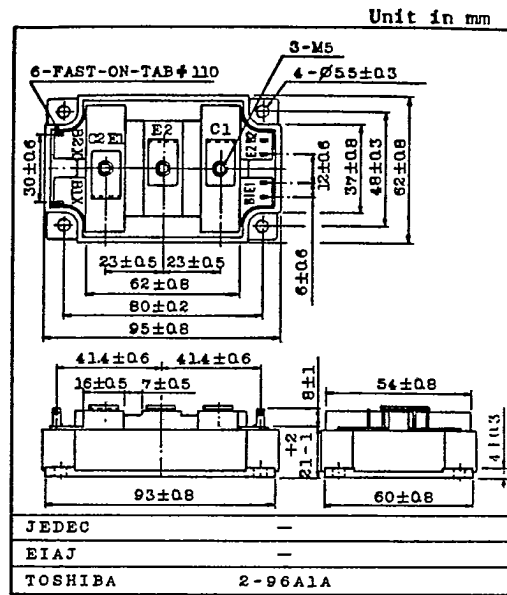
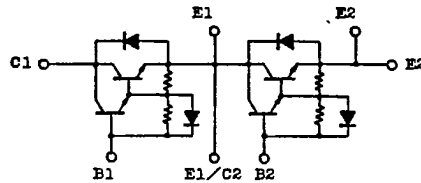
## TECHNICAL DATA

TOSHIBA GTR MODULE  
 MG100G2YL1  
 SILICON NPN TRIPLE DIFFUSED TYPE

HIGH POWER SWITCHING APPLICATIONS.  
 MOTOR CONTROL APPLICATIONS.

- The Collector is Isolated from Case
- With Built-in Free Wheeling Diode
- High DC Current Gain:  $h_{FE}=100(\text{Min.})(I_C=100A)$
- Low Saturation Voltage  
     :  $V_{CE}(\text{sat})=2V(\text{Max.})(I_C=100A)$
- High Speed  
     :  $t_f=2\mu s(\text{Max.})(I_C=100A)$

EQUIVALENT CIRCUIT



Weight : 385g

MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$ )

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	VCBO	600	V
Collector-Emitter Sustaining Voltage	VCEX(SUS)	600	V
	VCEO(SUS)	450	
Emitter-Base Voltage	VEBO	6	V
Collector Current	DC	$I_C$	A
	1ms	$I_{CP}$	
Forward Current	DC	$I_F$	A
	1ms	$I_{FM}$	
Base Current	$I_B$	10	A
Collector Power Dissipation ( $T_c=25^\circ\text{C}$ )	PC	400	W
Junction Temperature	$T_j$	150	$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	-40-125	$^\circ\text{C}$
Isolation Voltage	$V_{isol}$	2500 (AC 1 Minute)	V
Screw Torque (Terminal/Mounting)	-	30/30	kg·cm

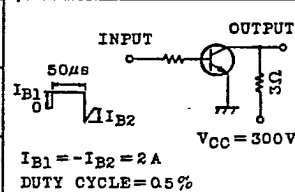
MG100G2YL1-1

TOSHIBA CORPORATION

**TOSHIBA** SEMICONDUCTOR  
 TECHNICAL DATA

MG100G2YL1

## ELECTRICAL CHARACTERISTICS (Ta=25°C)

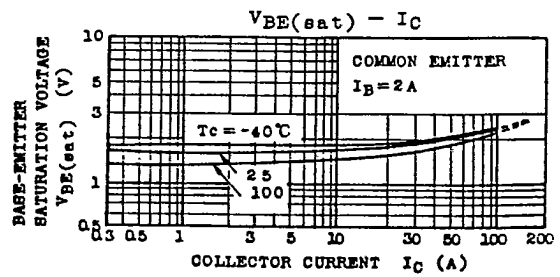
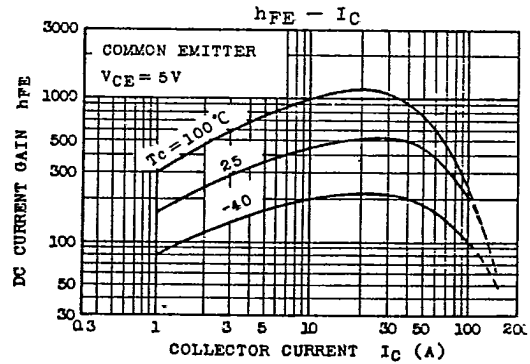
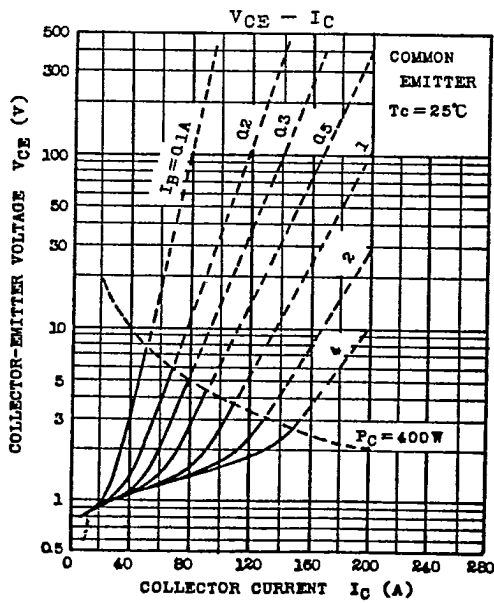
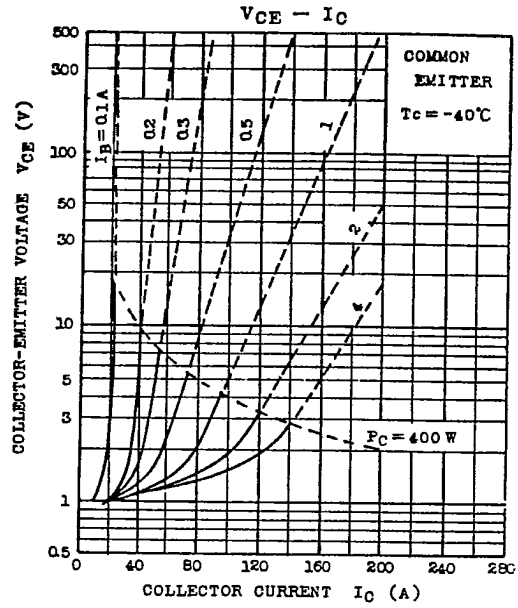
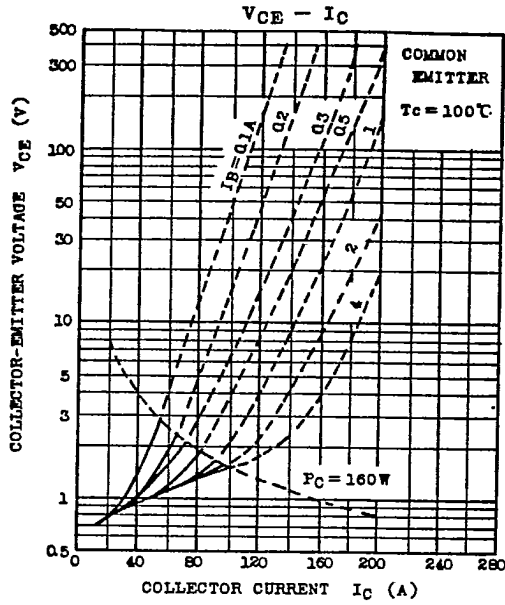
CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current		ICBO	V <sub>CB</sub> =600V, I <sub>E</sub> =0	-	-	2.0	mA
Emitter Cut-off Current		IEBO	V <sub>EB</sub> =6V, I <sub>C</sub> =0	-	-	200	mA
Collector-Emitter Sustaining Voltage		V <sub>CEO(SUS)</sub>	I <sub>C</sub> =0.5A, L=40mH	450	-	-	V
DC Current Gain		h <sub>FE</sub>	V <sub>CE</sub> =5V, I <sub>C</sub> =100A	100	-	-	
Collector-Emitter Saturation Voltage		V <sub>CE(sat)</sub>	I <sub>C</sub> =100A, I <sub>B</sub> =2A	-	1.5	2.0	V
Base-Emitter Saturation Voltage		V <sub>BE(sat)</sub>		-	2.2	2.7	V
Switching Time	Turn-on Time	t <sub>on</sub>	 <p>INPUT      OUTPUT</p> <p>50µs</p> <p>I<sub>B1</sub>      I<sub>B2</sub></p> <p>I<sub>C</sub></p> <p>V<sub>CE</sub></p> <p>V<sub>CC</sub> = 300V</p> <p>I<sub>B1</sub> = -I<sub>B2</sub> = 2A DUTY CYCLE = 0.5%</p>	-	1.2	2.0	µs
	Storage Time	t <sub>stg</sub>		-	7	12	
	Fall Time	t <sub>f</sub>		-	1.0	2.0	
Forward Voltage		V <sub>F</sub>	I <sub>F</sub> =100A, I <sub>B</sub> =0	-	1.3	1.7	V
Reverse Recovery Time		t <sub>rr</sub>	I <sub>F</sub> =100A, V <sub>BE</sub> =-3V di/dt=100A/µs	-	-	1.5	µs
Thermal Resistance		R <sub>th(j-c)</sub>	Transistor	-	-	0.31	°C/W
			Diode	-	-	1.3	

MG100G2YL1-2

TOSHIBA CORPORATION

**TOSHIBA** SEMICONDUCTOR  
TECHNICAL DATA

MG100G2YL1

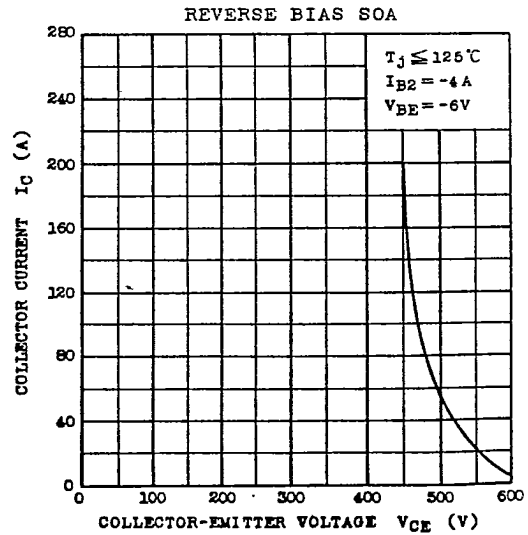
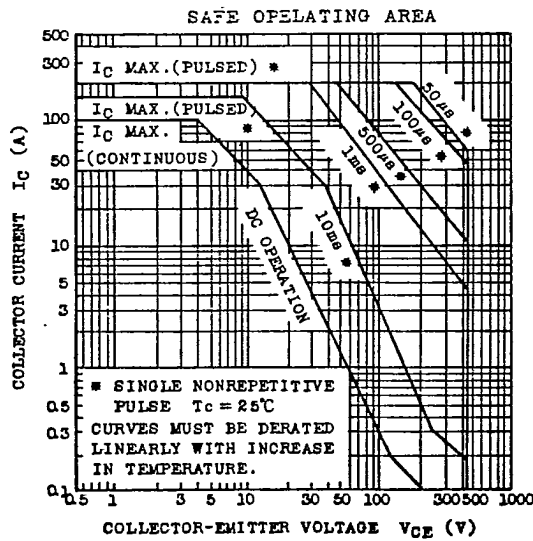
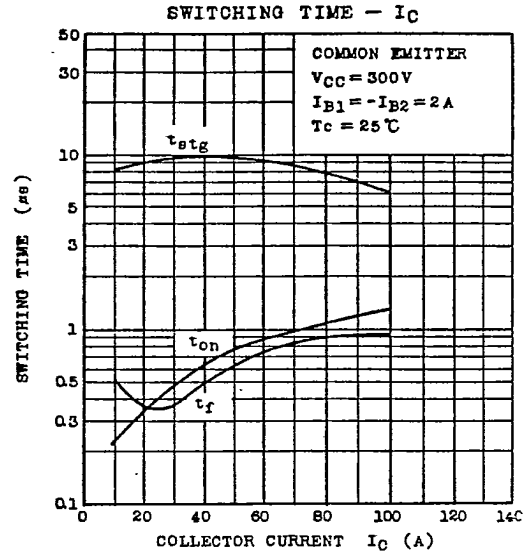
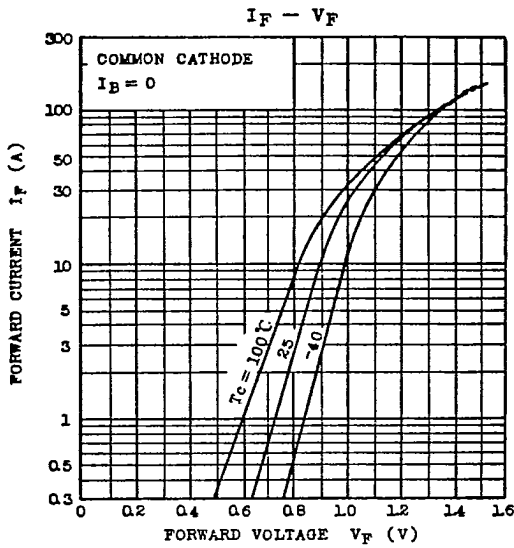


MC100G2YL1-3  
TOSHIBA CORPORATION

GT1A2(2)

**TOSHIBA** SEMICONDUCTOR  
TECHNICAL DATA

MG100G2YL1



9097250 TOSHIBA (DISCRETE/OPTO)

90D 16026 DT-33-3S

# TOSHIBA SEMICONDUCTOR

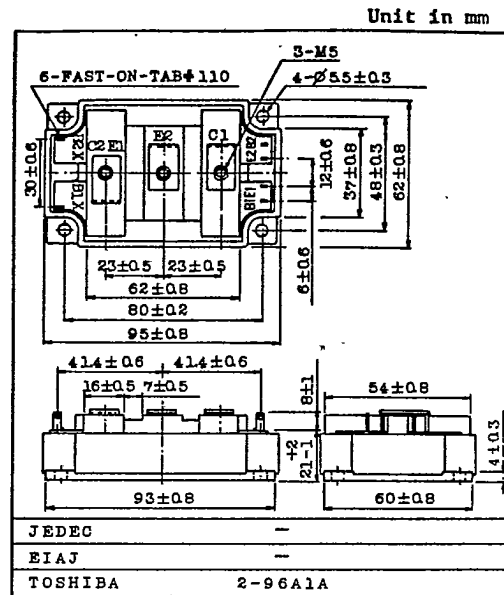
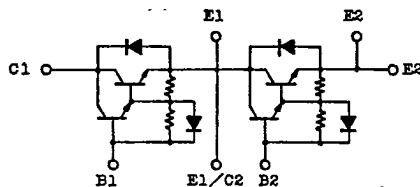
## TECHNICAL DATA

TOSHIBA GTR MODULE  
 MG100H2YL1  
 SILICON NPN TRIPLE DIFFUSED TYPE

HIGH POWER SWITCHING APPLICATIONS.  
 MOTOR CONTROL APPLICATIONS.

- The Collector is Isolated from Case
- With Built-in Free Wheeling Diode
- High DC Current Gain:  $h_{FE}=80(\text{Min})(I_C=100A)$
- Low Saturation Voltage  
 :  $V_{CE}(\text{sat})=2V(\text{Max.})(I_C=100A)$
- High Speed :  $t_f=4\mu s(\text{Max.})(I_C=100A)$

## EQUIVALENT CIRCUIT



Weight : 385g

MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$ )

CHARACTERISTIC		SYMBOL	RATING	UNIT
Collector-Base Voltage		VCBO	600	V
Collector-Emitter Sustaining Voltage		VCEX(SUS)	600	V
		VCEO(SUS)	550	
Emitter-Base Voltage		VEBO	6	V
Collector Current	DC	IC	100	A
	1ms	ICP	200	
Forward Current	DC	IF	100	A
	1ms	IFM	200	
Base Current		IB	15	A
Collector Power Dissipation ( $T_c=25^\circ\text{C}$ )		PC	400	W
Junction Temperature		Tj	150	$^\circ\text{C}$
Storage Temperature Range		Tstg	-40-125	$^\circ\text{C}$
Isolation Voltage		Visol	2500 (AC 1 Minute)	V
Screw Torque (Terminal/Mounting)		-	30/30	kg·cm

MG100H2YL1-1

TOSHIBA CORPORATION

9097250 TOSHIBA (DISCRETE/OPTO)

900 16027 DT-33-35

# TOSHIBA SEMICONDUCTOR

## TECHNICAL DATA

MG100H2YL1

## ELECTRICAL CHARACTERISTICS (Ta=25°C)

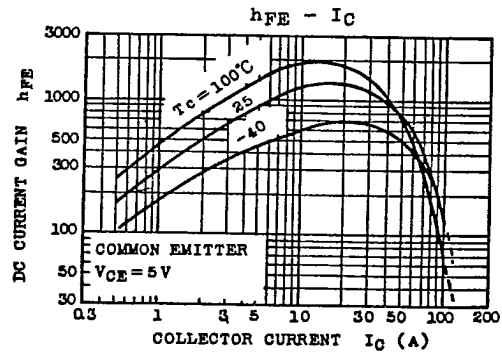
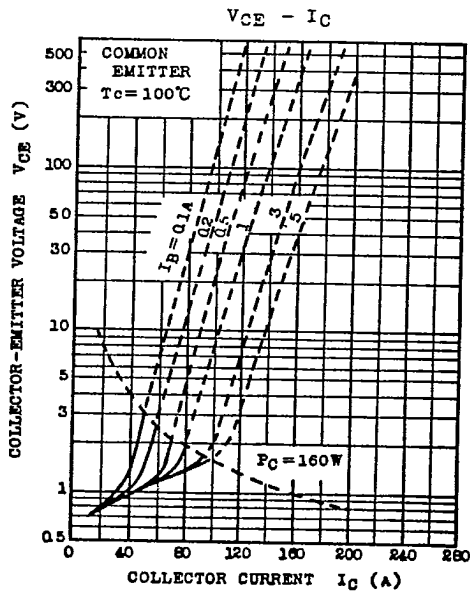
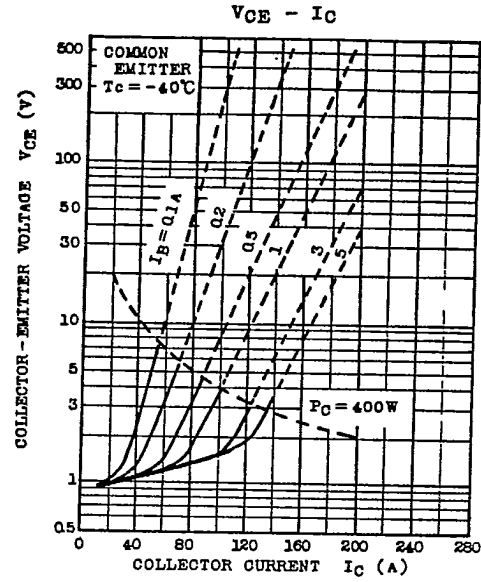
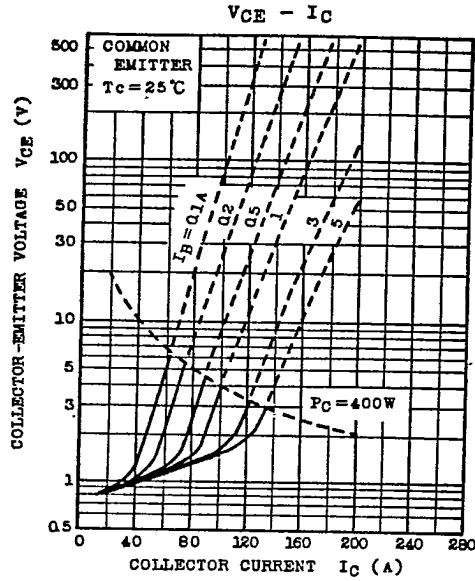
CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current		ICBO	V <sub>CB</sub> =600V, I <sub>E</sub> =0	-	-	1.0	mA
Emitter Cut-off Current		IEBO	V <sub>EB</sub> =6V, I <sub>C</sub> =0	-	-	200	mA
Collector-Emitter Sustaining Voltage		V <sub>CEO(SUS)</sub>	I <sub>C</sub> =0.5A, L=40mH	550	-	-	V
DC Current Gain		h <sub>FE</sub>	V <sub>CE</sub> =5V, I <sub>C</sub> =100A	80	-	-	
Collector-Emitter Saturation Voltage		V <sub>CE(sat)</sub>	I <sub>C</sub> =100A, I <sub>B</sub> =3A	-	-	2.0	V
Base-Emitter Saturation Voltage		V <sub>BE(sat)</sub>		-	-	2.7	V
Switching Time	Turn-on Time	t <sub>on</sub>	<p>INPUT OUTPUT 50µs I<sub>B1</sub> I<sub>B2</sub> C<sub>L</sub> V<sub>CE</sub>=300V I<sub>B1</sub> = -I<sub>B2</sub> = 3A DUTY CYCLE = 0.5%</p>	-	-	2.0	µs
	Storage Time	t <sub>stg</sub>		-	-	12	
	Fall Time	t <sub>f</sub>		-	-	4.0	
Forward Voltage		V <sub>F</sub>	I <sub>F</sub> =100A, I <sub>B</sub> =0	-	-	1.7	V
Reverse Recovery Time		t <sub>rr</sub>	I <sub>F</sub> =100A, V <sub>BE</sub> =-3V di/dt=100A/µs	-	-	1.5	µs
Thermal Resistance		R <sub>th(j-c)</sub>	Transistor	-	-	0.31	°C/W
			Diode	-	-	1.3	

MG100H2YL1-2

TOSHIBA CORPORATION

**TOSHIBA** SEMICONDUCTOR  
TECHNICAL DATA

MG100H2YL1



GT1A2(2)

MG100H2YL1-3  
TOSHIBA CORPORATION

